IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Chung-Chieh Fang	§	Docket No.: 24061.106 (TSMC2003.0551)
Serial No.: 10/809,985	§ §	Examiner: TBD
Filed: March 26, 2004	§ §	Art Unit: 3623
For: Semiconductor Manufacturing Capacity Features Exchange System	9 9 1 § 8	Conf. No.: 9614

REQUEST FOR CORRECTED FILING RECEIPT

Commissioner of Patents

Attention: Office of Initial Patent Examination's Filing Receipt Corrections

PO Box 1450

Alexandria, VA 22313-1450

Dear Sir:

Attached is a copy of the official filing receipt received from the United States Patent and Trademark Office in the above-identified patent application in which issuance of a corrected filing receipt is respectfully requested.

Applicants request correction of the spelling of the named inventor to read as follows:

Chung-Chieh Fang

Enclosed herewith is an executed Declaration, which lists the correct spelling of the inventor's name. Applicants respectfully request approval and issuance of a corrected filing receipt.

No fee is believed to be due. However, the Commissioner is hereby authorized to charge any fees or credit any overpayments associated with this communication to Deposit Account No. 08-1394.

Respectfully submitted

David M. O'Dell Registration No. 42,044

Date: September 15, 2006

HAYNES AND BOONE, LLP 901 Main Street, Suite 3100 Dallas, Texas 75202-3789 Telephone: 972/739-8626 Facsimile: 214/200-0853 PATENT / DOCKET NO.: 24061.106 /TSMC2003-0551 CUSTOMER NO. 42717

INVENTOR'S DECLARATION FOR PATENT APPLICATION

As below named inventor, I hereby declare that:

is attached hereto.

_X

R

D-1205266.1

Our residence, post office address and citizenship are as stated below next to our names;

under Attorney's Docket Number 24061.106 (TSMC2003-0551)

was filed on March 26, 2004

as Application Serial No. 10/809,985 and was amended on_____

I believe I are the original, first and sole joint inventors of the subject matter which is claimed and for which a patent is

SEMICONDUCTOR MANUFACTURING CAPACITY FEATURES EXCHANGE SYSTEM the specification of which: (check one)

I hereby authorize the attorney of record to update this document to include Patent Office information as deemed necessary I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims,

_____ (if applicable).

I acknowledge the duty to disclose information which is material to the patentability of this application in accordance with 37 CFR 1.56, including for continuation-in-part applications, material information which became available between the filing date of the prior application and the national or PCT international filing date of the continuation-in-part application.
I hereby declare that all statements made herein of our own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under 18 U.S.C 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.
FULL NAME OF INVENTOR: Chung-Chieh Fang
INVENTOR'S SIGNATURE: Chung-Chash Frang DATED: Sept. 14, 2006
RESIDENCE and POST OFFICE ADDRESS: 374 Taylor Ave. Apt. 1 Moscow ID 83843, USA CITIZENSHIP: Taiwan, R.O.C.
R-70653.1



United States Patent and Trademark Office

UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office

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FILING OR 371 (c) DATE APPL NO. ART UNIT FIL FEE REC'D ATTY. DOCKET NO DRAWINGS TOT CLMS IND CLMS 10/809.985 03/26/2004 3623 990 24061.106 (TSMC2003.0551)

42717 HAYNES AND BOONE, LLP 901 MAIN STREET, SUITE 3100 DALLAS, TX 75202

CONFIRMATION NO. 9614 UPDATED FILING RECEIPT *OC000000013353393* *OC00000013353393*

Date Mailed: 07/27/2004

Receipt is acknowledged of this regular Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Filing Receipt Corrections, facsimile number 703-746-9195. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

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Chung-Chien Fang, Hsin-Chu, TAIWAN:

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HAYNES & BOONE LLP

Assignment For Published Patent Application

Domestic Priority data as claimed by applicant

Taiwan Semiconductor Manufacturing Co., Ltd., Hsin-Chu, TAIWAN:

Foreign Applications

If Required, Foreign Filing License Granted: 06/04/2004

Projected Publication Date: 09/29/2005

Non-Publication Request: No

Early Publication Request: No

24061.106

3.26.05-DD+0F 5.26.05 - awaiting OA

Dockstod 7.30.04

DMO-MK-JRM

Title

Semiconductor manufacturing capacity features exchange system

Preliminary Class

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